I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: July 27, 2009 Signature:

ignature: ____

Docket No.: APPM/8244/DSM/MCVD/JW 1016.014014

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of:

Yuxiang May Wang

Serial No.: 10/799,146

Confirmation No.: 7933

Filed:

March 12, 2004

For:

METHOD OF DEPOSITING

AN AMORPHOUS

CARBON FILM FOR ETCH

HARDMASK APPLICATION Group Art Unit: 2893

Examiner:

M. D. Harrison

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT (SIDS)

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Commissioner:

Pursuant to 37 CFR 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO/SB/08. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Supplemental Information Disclosure Statement is filed more than three months after the U.S. filing date, OR more than three months after the date of entry of the national stage of a PCT application, AND after the mailing date of the first Office Action on the merits, whichever occurs first, but before the mailing date of a Final Office Action or Notice of Allowance (37 CFR 1.97(c)).

Application No.: 10/799,146 Docket No.: APPM/8244US

I hereby certify, pursuant to 37 CFR 1.97(e)(1), that each item of information contained in this Supplemental Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Supplemental Information Disclosure Statement.

In accordance with 37 CFR 1.98(a)(2)(ii), Applicant has not submitted copies of U.S. patents and U.S. patent applications. Applicant submits herewith copies of foreign patents and non-patent literature in accordance with 37 CFR 1.98(a)(2).

In accordance with 37 CFR 1.97(g), the filing of this Supplemental Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 CFR 1.56(a) exists. In accordance with 37 CFR 1.97(h), the filing of this Supplemental Information Disclosure Statement shall not be construed to be an admission that any patent, publication or other information referred to therein is "prior art" for this invention unless specifically designated as such.

It is submitted that the Supplemental Information Disclosure Statement is in compliance with 37 CFR 1.98 and the Examiner is respectfully requested to consider the listed references.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 20-0782, under Order No. APPM/8244/KMT.

1266641_1 2

Docket No.: APPM/8244US

Respectfully submitted,

Keith M. Tackett

By

Registration No.: 32,008

PATTERSON & SHERIDAN, LLP 3040 Post Oak Blvd, Suite 1500

Houston, Texas 77056 Telephone: (713) 623-4844 Facsimile: (713) 623-4846 Attorney For Applicant